Semiconductor Solutions for High Speed Communication and Fiber Optic Applications

FOA4400 16:1 MUX

Multiplexer with Clock Multiplication Unit

MUX 39.8 - 43 Gbit/s, 5.5 V

FOA9400 1:1 FIFO Data Synchronization FIFO 2.5 - 2.7 Gbit/s, 5.5 V

FOA5400 2:16 DEMUX

Demultiplexer

DEMUX 39.8 - 43 Gbit/s, 5.5 V

FOA5401 1:2 CDR

Clock and Data Recovery with 1:2 Demultiplexer

CDR 39.8 - 43 Gbit/s, 5.5 V

The 40 Gbit/s transceiver chipset (MUX+FIFO and CDR+DEMUX) provide highly integrated SerDes (SERializer-DESerializer) functionality with a 1:16 ratio. The 16 times 2.5 Gbit/s data signals are multiplexed to a single serial 40 Gbit/s data stream and vice versa. The devices support datarates from 39.8 Gbit/s up to 43 Gbit/s (OC-768/STM-256) with optional FEC (Forward Error Correction). All four chips are manufactured in Infineon's leading-edge Silicon-Germanium B7HF technology enabling low power consumption.

The multiplexer FOA4400, FIFO FOA9400, demultiplexer FOA5400 and CDR FOA5401 feature CML interfaces, integrated VCOs (Voltage-Controlled Oscillator) and two reference clocks (622 MHz/2.5 GHz). The FOA4400 incorporates the CMU and selectable 20 GHz and 40 GHz clock outputs, whereas optional data synchronization is provided by the FOA9400. The FOA5400 and FOA5401 integrate CDR and demultiplexing functionality with extremely high input sensitivity.



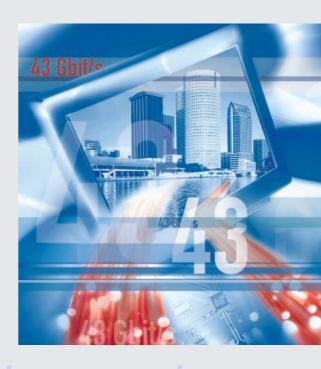
- Supports data rates from 39.8 Gbit/s to 43 Gbit/s
- Infineon's leading-edge SiGe B7HF technology
- 1:16 (= 1:2 and 2:16) and 16:1 multiplexing ratio
- On-chip VCO, external VCO input available
- 622 MHz or 2.5 GHz reference clock
- Adjustable sampling threshold and phase
- Integrated pre-amplifier with high input sensitivity
- Selectable 20 GHz and 40 GHz output clock
- FIFO depth of 6 Bits

Typical Applications

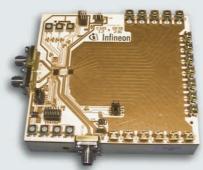
- Fiber optics telecom and datacom applications
- SONET/SDH OC-768/STM-256 with and without FEC

Main Advantages

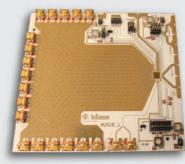
- Data rate from 39.8 Gbit/s up to 43 Gbit/s
- SiGe chipset providing complete functionality: CMU, CDR, FIFO and VCO
- Single supply voltage of 5.5 V
- High CDR sensitivity with adjustable sampling
- On-chip VCO together with external VCO input



CDR-DEMUX Evaluation Board



MUX Evaluation Board



FOA4400/9400/ 5400/5401

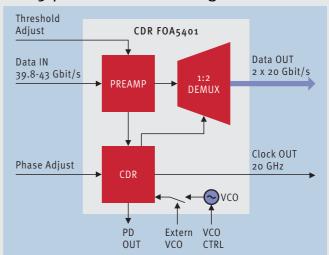
MUX/FIFO/DEMUX/CDR 39.8 - 43 Gbit/s, 5.5 V



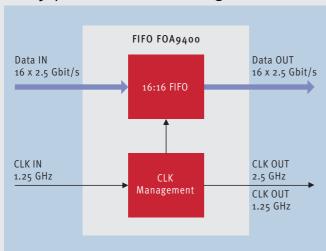
FOA4400 MUX Block Diagram

Data IN MUX FOA4400 16 x 2.5 Gbit/s Data OUT Clock IN 39.8-43 Gbit/s 2.5 GHz MUX Clock OUT Register 2.5 GHz Clock OUT Clock OUT 20 GHz 622 MHz CMU Clock OUT 40 GHz PD Extern PD Reference Clock VCO VCO OUT 622 MHz / 2.5 GHz

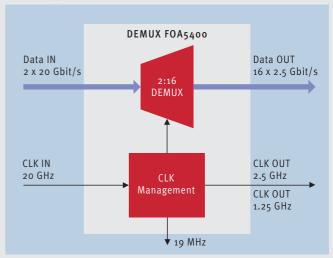
FOA5401 CDR Block Diagram



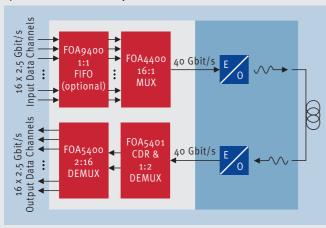
FOA9400 FIFO Block Diagram



FOA5400 DEMUX Block Diagram



40 Gbit/s Chipset Overview



Packing

Туре	Sales Code	Package
MUX 16:1	FOA4400	Bare Die
FIFO 1:1	FOA9400	Bare Die
DEMUX 2:16	FOA5400	Bare Die
CDR 1:2	FOA5401	Bare Die

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